



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

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Alan G. Wood
Trung Tri Doan
David R. Hembree

Group Art Unit: 2607

Examiner: Karlsen, E.

Serial No.: 08/120,628

Filing Date: September 13, 1993

Title: (as amended)
BONDPAD ATTACHMENTS HAVING
SELF-LIMITING PROPERTIES FOR
PENETRATION OF SEMICONDUCTOR DIE

Attorney Docket No.: 91-62.7

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GROUP 260
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AMENDMENT

Honorable Commissioner of Patents and Trademarks
Box Amendment (Non-Fee)
Washington D.C. 20231

Sir:

In response to the Office Action dated April 7, 1994
having a statutory period for response set to expire on July
7, 1994, please amend the captioned case as follows:

In the specification

In the Abstract, line 10, delete "and" first occurrence.

Page 16,

line 14, delete "circuit trace";
line 15-16, delete "circuit trace".

Page 17,

lines 10-14, delete "copending U.S. Patent
Application serial no. 7/898,617, filed 06/15/92,
for PROCESS FOR FORMING RAISED SURFACE

GP267
#7/c
7-12-94
TH
Viner
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WLB